

SPECIFICATIONS

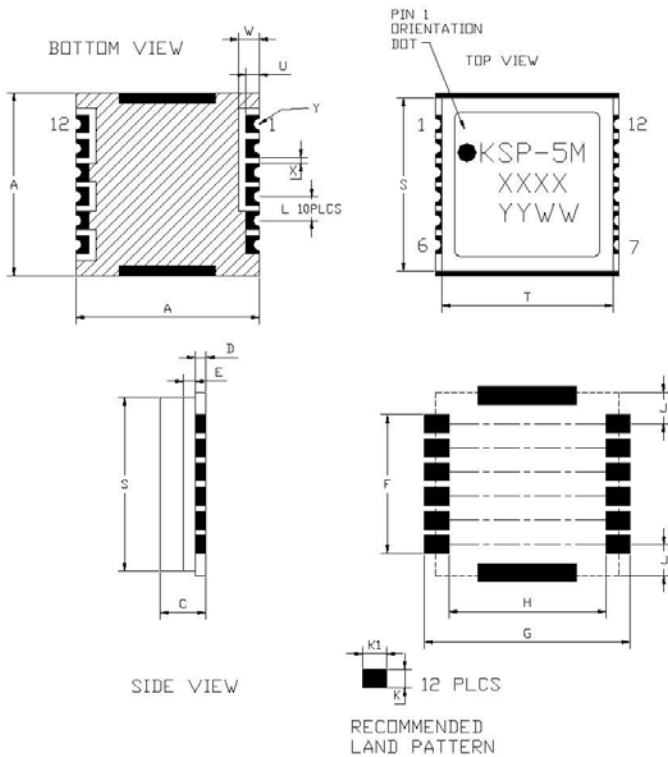
DIMENSIONS

NOTE: UNLESS CASE OTHERWISE SPECIFIED:

1. THE METAL CASE IS GROUND.
2. ALL HALF VIA CONTACTS ARE PLATED THRU FROM THE PAD ON THE TOP SIDE TO THE PAD ON THE BOTTOM SIDE OF THE BOARD.
3. CROSS HATCHED AREAS ARE GROUND AND ARE COVERED WITH LPI SOLDER MASK OVER BARE COPPER. ALL CONTACT AREAS ARE PLATED WITH Sn63/Pb37 SOLDER.
4. SUBSTRATE MATERIAL : FR-4.
5. XXXX REPRESENTS THE MODEL NUMBER.
6. YYWW IS THE DATE CODE.(LOT CODE)

PIN OUT FOR PLL			
PIN	APPLICATION	PIN	APPLICATION
1	CLOCK	7	VCC (VCO)
2	DATA	9	RF OUT
3	ENABLE	11	LOCK DETECT
4	REF. OSC IN	12	VCP (CHIP)

ALL OTHER PINS ARE GROUND



SYMBOL	DIMENSION
	MILLIMETERS
A	15.2±0.3
C	4.0 MAX
D	0.9 MAX
E	0.6
F	11.5
G	17.0
H	13.0
J	2.6
K	1.5
K1	2.0
L	2.0
S	14.4
T	14.2
U	1.1
W	1.7
X	0.5
Y	0.5

CALL OUR SALES DEPARTMENT FOR MORE INFORMATION OR VARIATIONS OF THIS PRODUCT.

**Corry Micronics, Inc. One Plastics Rd. - Corry, PA 16407
(814) 664-7728 Fax (814) 664-4582 www.cormic.com**

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